



AH3241Q, AH3242Q, AH3243Q AH3280Q, AH3281Q, AH3282Q

TWO-WIRE AUTOMOTIVE HALL EFFECT **UNIPOLAR / LATCH SWITCHES INTEGRATED SELF-DIAGNOSTICS**

Description

The AH3241Q, AH3242Q, AH3243Q, AH3280Q, AH3281Q, and AH3282Q are high voltage, high sensitivity two-wire Hall Effect Unipolar/Latch switch ICs with integrated self-diagnostics and automotive-compliant AEC-Q100 qualification; designed for position and proximity sensing in automotive applications, such as seat and seatbelt buckle, transmission actuator, gear position, wiper, door/trunk closure, etc.

To support a wide range of demanding applications, the AH3241Q, AH3242Q, AH3243Q, AH3280Q, AH3281Q, and AH3282Q are optimized to operate over a supply range of 2.7V to 27V. These features include a chopper-stabilized architecture and an internal bandgap regulator to provide temperature compensated supply for internal circuits. For robustness and protection, the device has built-in reverse blocking diode with a Zener clamp on the supply.

The built-in thermal protection also shuts down the chip if temperature rises to an abnormal value. This will automatically restart the chip once the junction temperature drops below the safe value.

For AH3241Q, AH3242Q, and AH3243Q 2-wire unipolar switches: when the flux density (south pole) exceeds B_{OP}, the supply current state is turned on (low or high). The output is held until a magnetic flux density falls below B_{RP}, causing output current to be turned off.

For AH3280Q, AH3281Q, and AH3282Q 2-wire latch switches: when the magnetic flux density is larger than BOP, output current is turned on (high). The output state is held until a magnetic flux density reversal falls below B_{RP}, causing output current to be turned off (low).

Features and Performance

- Unipolar: AH3241Q, AH3242Q, AH3243Q •
- Latch: AH3280Q, AH3281Q, AH3282Q
- **Output Polarity:** •
 - Direct: AH3242Q, AH3243Q
 - Inverted: AH3241Q
- Wide Supply Voltage Operation: 2.7V to 27V
- Temperature Coefficient -1100ppm/°C (AH3242Q, AH3243Q)
- Chopper Stabilized Design Provides:
 - Superior Temperature Stability
 - Minimal Switch Point Drift
 - Enhanced Immunity to Stress
- Battery polarity reverse connection protection
- **Transient Spike Voltage Protection** •
- Overtemperature Shut Down and Auto-Restart .
- **UVLO** Protection
- High ESD Rating: HBM = 8kV, CDM = 1kV
- Ready for ISO 26262
- Temperature Range: -40°C to +150°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1, 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The AH3241Q, AH3242Q, AH3243Q, AH3280Q, AH3281Q, and AH3282Q are suitable for automotive applications requiring specific change control; these parts are AEC-Q100 gualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

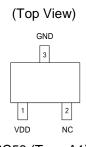
https://www.diodes.com/guality/product-definitions/

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- Lead-free

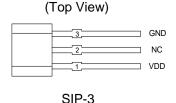
Notes:

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Assignments



SC59 (Type A1)

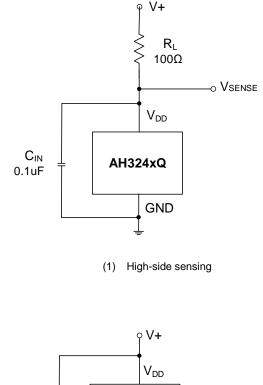


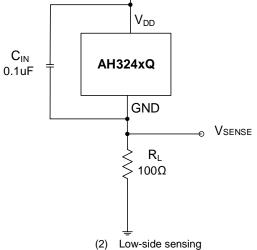
Applications

- Position and proximity sensing in automotive applications
- Seat positioning
- Seatbelt buckles
- Wiper positioning
- Window lifters
- Gear selection positioning



Typical Applications Circuit





Note: 4. A 100nF or larger decoupling capacitor (CIN) between VDD and GND pins is needed for power stabilization and to strengthen noise immunity; CIN needs to be as close to IC as possible. Typical RL value is 100Ω. Larger or additional series resistor is recommended if there are disturbances on VDD.

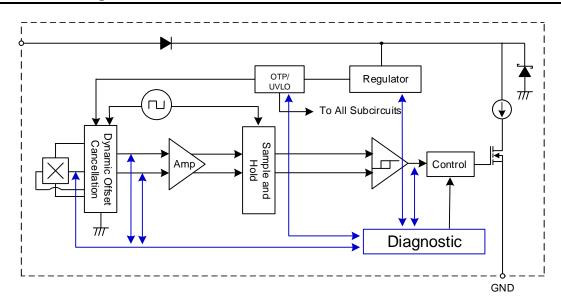
Pin Descriptions

Package: SC59 and SIP-3 (Ammo Pack and Bulk Pack)

Pin Number	Pin Name	Function
1	V _{DD}	Supply voltage input
2	NC	No connection; can be connected to V_{DD} , GND, or left open.
3	GND	Ground



Functional Block Diagram



Absolute Maximum Ratings (Note 5) (@ T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
V _{DD} (Note 6)	Supply Voltage	32	V
V _{DDR} (Note 6)	Reverse supply voltage	-32	V
В	Magnetic flux density	Unlimited	Gauss
T _{J_MAX}	Maximum junction temperature	180	°C
Ts	Storage Temperature	-55~180	°C
ESD (HBM)	ESD (Human Body Model)	8000	V
ESD (CDM)	ESD(Charged Device Model)	1000	V

Notes: 5. Stresses greater than the "Absolute Maximum Ratings" specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

6. Should not be exceeded the maximum junction temperature and maximum duration of 500ms.

Recommended Operating Conditions (@ T_A = -40°C to +150°C, T_J = -40°C to +165°C unless otherwise specified.)

Symbol	Parameter	Min	Мах	Unit
V _{DD}	Supply Voltage, between V_{DD} and GND pins	2.7	27	V
T _{OP}	Operating Ambient Temperature	-40	150	°C



Symbol	Parameter	Conditions	Min	Тур	Max	Units	
V _{DD}	Supply voltage (Note 8)	-	2.7	12	27	V	
I _{OFF} (2)	Supply current off state	V _{DD} = 2.7 to 27 V (AH3280Q, AH3282Q)	2	3.3	5	mA	
I _{OFF} (1)	Supply current off state	V _{DD} = 2.7 to 27 V (AH3241Q, AH3242Q, AH3243Q, AH3243Q, AH3281Q)	5	6	6.9	mA	
I _{ON}	Supply current on state	V _{DD} = 2.7 to 27 V	12	14.5	17	mA	
VUVLO	Undervoltage lockout threshold	Voltage dropping	-	2.2	2.7	V	
t _{UVLO}	Undervoltage lockout reaction time	-	-	10	-	μs	
I _{DDR}	Reverse supply current	V _{DD} = -18V, T = -40°C to +150°C	-1.5	-	-	mA	
T _{TP}	Thermal protection threshold	Junction temperature	-	190	-	°C	
T _{TPR}	Thermal protection release threshold	Junction temperature	-	180	-	°C	
F _M	Maximum magnet switching frequency	B > 3*B _{OP} , alternative square magnet field	30	50	-	kHz	
F _C	Chopping frequency	-	-	1000	-	kHz	
ISAFE	Safe mode supply current	Safe mode supply current / Error Current (mA)	0.5	1	1.5	mA	
T _{PON}	Power on delay time (Note 9)	B > Bop+10GS	-	28	40	μs	
TD	Response delay time (Note 10)	B > 3*B _{OP}	-	7	-	μs	
T _{RF}	Current rise/fall time	V_{DD} = 12V, No bypass capacitor, C_{LOAD} = 50pF to GND	0.1	0.3	1	μs	
POS	Power-up state (Notes 9, 11)	t > T _{PON} (max), V _{DD} slew rate > 1V/µs	-	IOFF	-	-	
-	Output jitter	B≥3*B _{OPMAX} 1000 successive square wave switching under 1KHz	-	±3.3	-	μs	

Notes: 7. Typical values are defined at TA = +25°C, VDD = 12V. Maximum and minimum values over the operating temperature range are not tested in production but guaranteed by design, process control and characterization.

8. VDD is the voltage between the VDD pin and the GND pin.

9. When power is initially turned on, V_{DD} must be operated in the correct voltage range to guarantee proper magnetic field sampling, output supply current state level is valid after the start up time of 28µs from V_{DD} higher than 2.7V. Guaranteed by design.

10. Time delayed from the magnetic threshold reached to the output rise or fall.

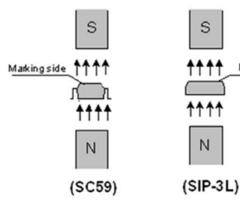
11. t > T_{PON} and $B_{RP} < B < B_{OP}$.

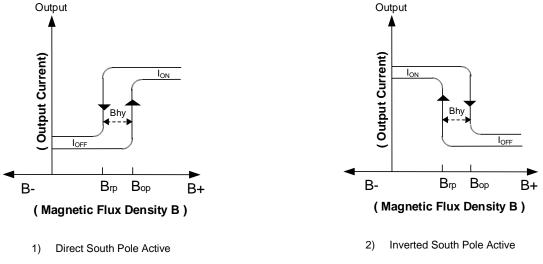


Magnetic Characteristics (Notes 12, 13) ($T_A = -40^{\circ}C$ to $+150^{\circ}C$, $T_J = -40^{\circ}C$ to $+165^{\circ}C$, $V_{DD}= 2.7V$ to 27V, unless otherwise specified)

Part Name	Test Condition		rating Po op(Gauss			ease Poir - (Gauss)		Temperature Coefficient (ppm/°C)	I _{OFF} (mA)	Active Pole	Output Polarity
		Min	Тур	Max	Min	Тур	Max	Тур	Тур		
AH3241Q	T _A =25°C	65	90	120	45	70	100	0	6	0 11	
AH3241Q	T _A =-40~150°C	55	90	135	35	70	115	0	0	South	Inverted
AH3242Q	T _A =25°C	40	60	80	20	40	60	-1100	6	Counth	Direct
AH3242Q	T _A =-40~150°C	30	60	90	10	40	70	-1100	0	South	Direct
AH3243Q	T _A =25°C	27	45	63	10	28	46	-1100	6	South	Direct
AH3243Q	T _A =-40~150°C	20	45	70	3	28	53	-1100	0		
AH3280Q	T _A =25°C	8	18	28	-28	-18	-8	0	3.3	South	Direct
AU3200Q	T _A =-40~150°C	3	18	33	-33	-18	-3	0	3.3		
AH3281Q	T _A =25°C	8	18	28	-28	-18	-8	0	6	Occuth	Direct
AUSZOIA	T _A =-40~150°C	3	18	33	-33	-18	-3	0	0	South	Direct
AH3282Q	T _A =25°C	15	30	45	-45	-30	-15	0	3.3	Quality	Direct
AUJZOZO	T _A =-40~150°C	10	30	50	-50	-30	-10	0	0 3.3 South	South	Direct

Markingside



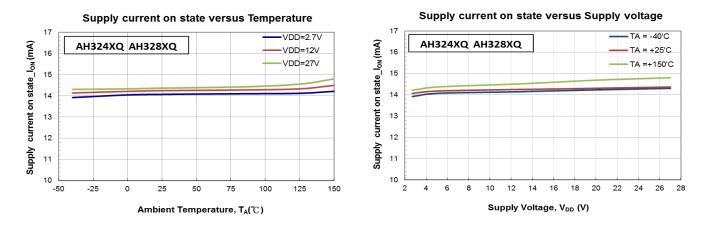


Notes: 12. Positive x-axis direction indicates the South Pole approaching the part marking surface of SIP3 and SC59 i.e. increasing south pole magnetic field strength to the sensor; reversing direction x-axis toward 0 means the decreasing south magnetic field strength to the sensor. Negative x-axis indicates north pole magnetic field to the part marking surface.

13. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.

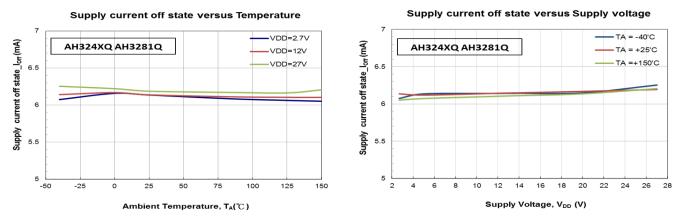


Typical Operating Characteristics

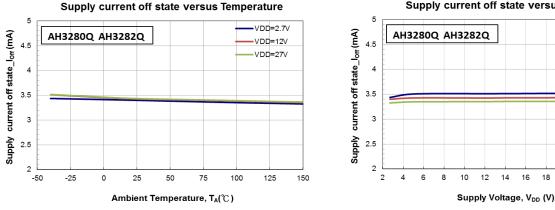


AH324XQ_AH328XQ Supply Current ON, Ion Performance

AH324XQ_AH3281Q Supply Current OFF, I_{OFF}(1) Performance







Supply current off state versus Supply voltage

12 14 16 18 20

AH3241Q, AH3242Q, AH3243Q AH3280Q, AH3281Q, AH3282Q Document number: DS41822 Rev. 4 - 2

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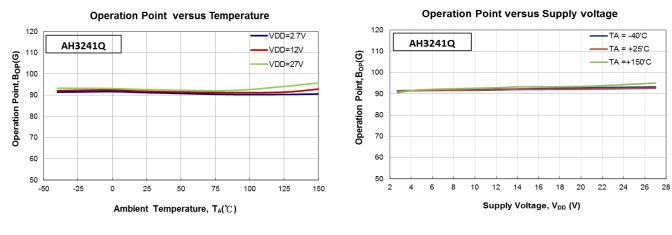
-TA= -40'C

- TA=+25'C

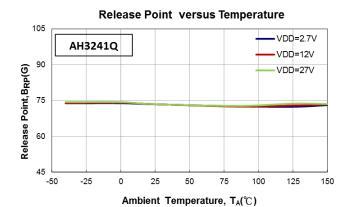
22 24 26

TA=+150'C

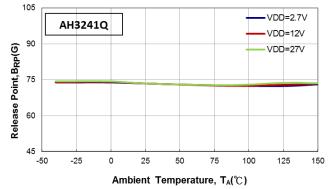


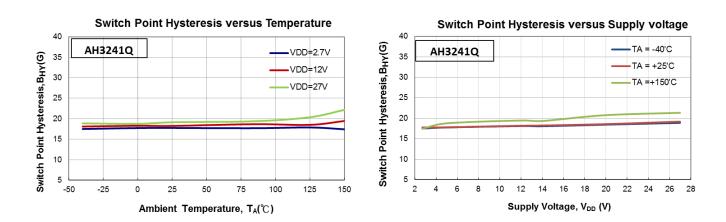


AH3241Q Magnetic Characteristics Performance

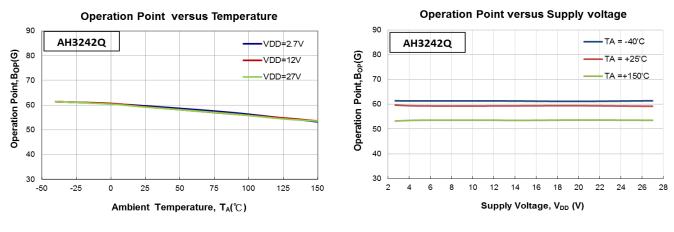


Release Point versus Temperature

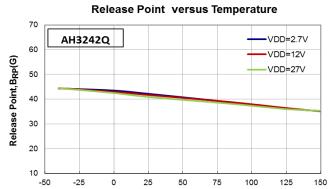






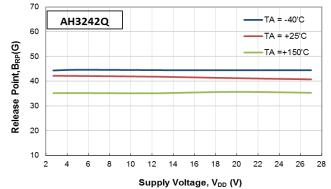


AH3242Q Magnetic Characteristics Performance



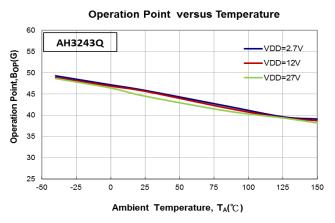
Ambient Temperature, $T_A(^{\circ}C)$

Release Point versus Supply voltage

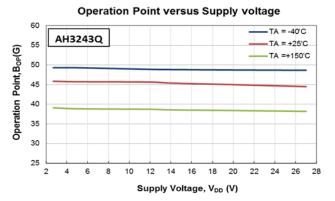


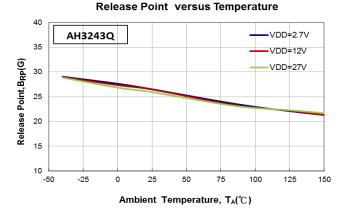
Switch Point Hysteresis versus Temperature Switch Point Hysteresis versus Supply voltage 40 40 Switch Point Hysteresis, B_{HY}(G) Switch Point Hysteresis, B_{HY}(G) AH3242Q AH3242Q VDD=2.7V -TA = -40'C 35 35 -TA = +25'C VDD=12V 30 30 -TA =+150'C VDD=27V 25 25 20 20 15 15 10 10 5 5 4 6 8 12 14 16 18 20 22 24 26 28 -50 -25 0 25 75 100 125 150 2 10 50 Supply Voltage, V_{DD} (V) Ambient Temperature, T_A(℃)



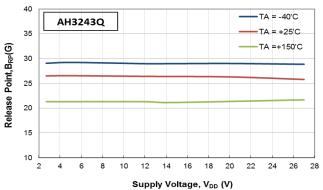


H3243Q Magnetic Characteristics Performance



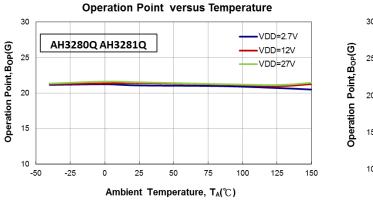


Release Point versus Supply voltage

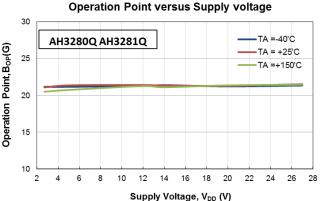


Switch Point Hysteresis versus Temperature Switch Point Hysteresis versus Supply voltage 35 35 Switch Point Hysteresis, B_{HY}(G) Switch Point Hysteresis, B_{HY}(G) AH3243Q AH3243Q VDD=2.7V - TA = -40'C 30 30 VDD=12V - TA = +25'C VDD=27V -TA =+150'C 25 25 20 20 15 15 10 10 5 5 4 16 18 20 22 24 26 2 6 8 10 12 14 28 -50 -25 0 25 50 75 100 125 150 Supply Voltage, V_{DD} (V) Ambient Temperature, T_A(℃)





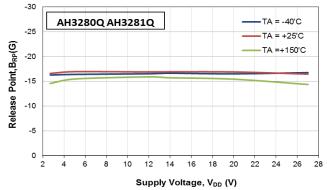
AH3280Q_AH3281Q Magnetic Characteristics Performance



Release Point versus Temperature -30 VDD=2.7V AH3280Q AH3281Q VDD=12V -25 VDD=27V Release Point, BRP(G) -20 -15 -10 -5 0 -50 -25 Ó 25 50 75 100 125 150

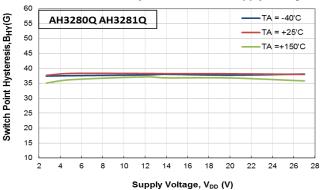
Ambient Temperature, T_A(℃)

Release Point versus Supply voltage



Switch Point Hysteresis versus Temperature 60 VDD=2.7V AH3280Q AH3281Q Switch Point Hysteresis, B_HY(G) 55 VDD=12V 50 VDD=27V 45 40 35 30 25 20 15 10 -50 -25 0 25 50 75 100 125 150 Ambient Temperature, T_A(℃)

Switch Point Hysteresis versus Supply voltage





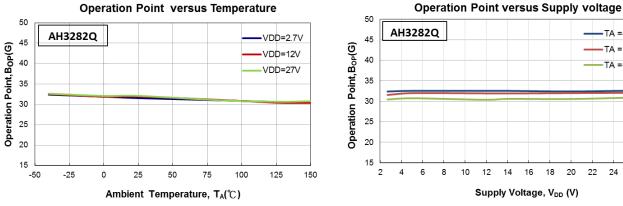
Release Point, BRP(G)

-15

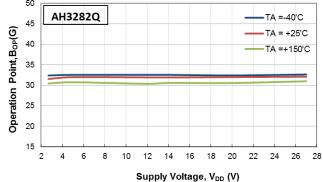
-10

-50

Typical Operating Characteristics (continued)



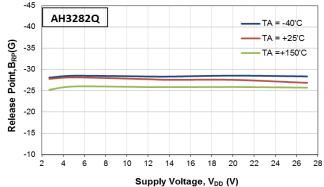
AH3282Q Magnetic Characteristics Performance



Release Point versus Temperature -45 AH3282Q VDD=2.7V -40 VDD=12V -35 VDD=27V -30 -25 -20

-25 25 50 75 100 0 125 Ambient Temperature, T_A(℃)

Release Point versus Supply voltage



Switch Point Hysteresis versus Temperature Switch Point Hysteresis versus Temperature 90 90 Switch Point Hysteresis, B_{HY}(G) Switch Point Hysteresis, B_{HY}(G) VDD=2.7V AH3282Q AH3282Q VDD=2.7V 80 80 VDD=12V VDD=12V VDD=27V VDD=27V 70 70 60 60 50 50 40 40 30 30 -50 -25 0 25 50 75 100 125 -50 -25 0 25 50 75 100 125 150 Ambient Temperature, $T_A(^{\circ}C)$ Ambient Temperature, T_A(℃)

150

AH3241Q, AH3242Q, AH3243Q AH3280Q, AH3281Q, AH3282Q Document number: DS41822 Rev. 4 - 2

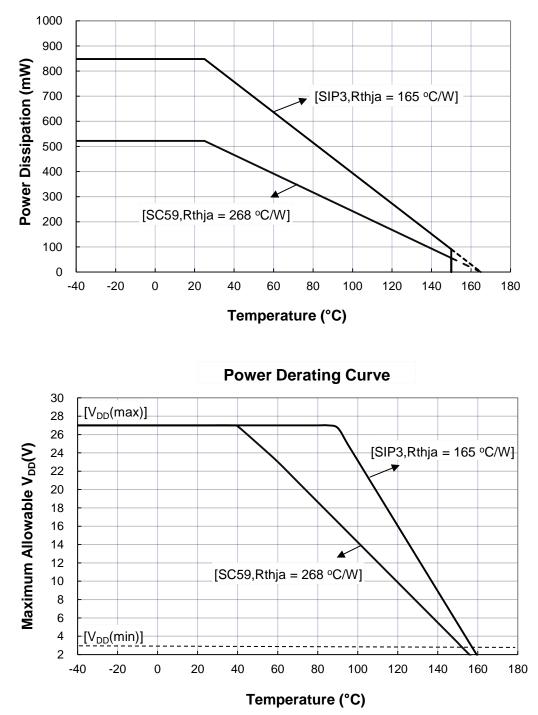
150



Thermal Performance Characteristics

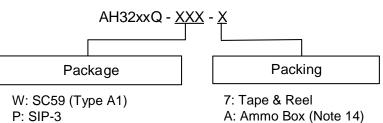
Symbol	Parameter	Conditions	Rating	Unit
-	Package Thermal Resistance	SC59, 50mm*50mm 2oz MRB PCB, single layer	268	°C/W
		SIP-3, 50mm*50mm 2oz MRB PCB, single layer	143	°C/W

Thermal Derating Curve vs. Ambient Temperature





Ordering Information



B: Bulk (Note 15)

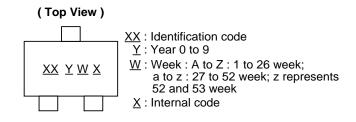
	Deekage		Bulk Box		7" Tape and Reel		Ammo Box	
Part Number	Package Code	Packaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3241Q-P-A	Р	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3241Q-P-B	Р	SIP-3 (Bulk Pack)	1000	-В	NA	NA	NA	NA
AH3241Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3242Q-P-A	Р	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3242Q-P-B	Р	SIP-3 (Bulk Pack)	1000	-В	NA	NA	NA	NA
AH3242Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3243Q-P-A	Р	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3243Q-P-B	Р	SIP-3 (Bulk Pack)	1000	-В	NA	NA	NA	NA
AH3243Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3280Q-P-A	Ρ	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3280Q-P-B	Р	SIP-3 (Bulk Pack)	1000	-В	NA	NA	NA	NA
AH3280Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3281Q-P-A	Р	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3281Q-P-B	Р	SIP-3 (Bulk Pack)	1000	-В	NA	NA	NA	NA
AH3281Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3282Q-P-A	Р	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3282Q-P-B	Р	SIP-3 (Bulk Pack)	1000	-В	NA	NA	NA	NA
AH3282Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA

Notes: 14. Ammo Box is for SIP-3 (Ammo Pack) Spread Lead. 15. Bulk is for SIP-3 (Bulk Pack) Straight Lead.



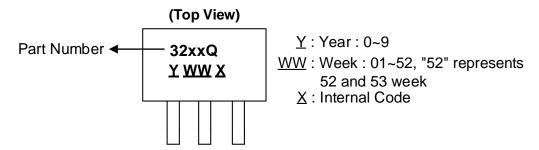
Marking Information

(1) Package Type: SC59 (Type-A1)



Part Number	Package	Identification Code
AH3241Q	SC59 (Type A1)	BR
AH3242Q	SC59 (Type A1)	BS
AH3243Q	SC59 (Type A1)	BT
AH3280Q	SC59 (Type A1)	BW
AH3281Q	SC59 (Type A1)	BU
AH3282Q	SC59 (Type A1)	BV

(2) Package Type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)



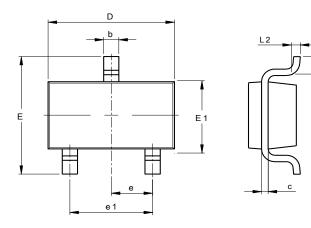
Part Number	Package	Identification Code
AH3241Q	SIP-3(Ammo Pack)	3241Q
AH3241Q	SIP-3 (Bulk Pack)	3241Q
AH3242Q	SIP-3(Ammo Pack)	3242Q
AH3242Q	SIP-3(Bulk Pack)	3242Q
AH3243Q	SIP-3(Ammo Pack)	3243Q
AH3243Q	SIP-3(Bulk Pack)	3243Q
AH3280Q	SIP-3(Ammo Pack)	3280Q
AH3280Q	SIP-3 (Bulk Pack)	3280Q
AH3281Q	SIP-3(Ammo Pack)	3281Q
AH3281Q	SIP-3 (Bulk Pack)	3281Q
AH3282Q	SIP-3 (Ammo Pack)	3282Q
AH3282Q	SIP-3 (Bulk Pack)	3282Q

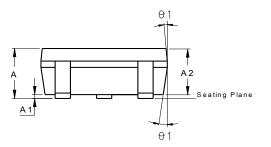


Package Outline Dimensions (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

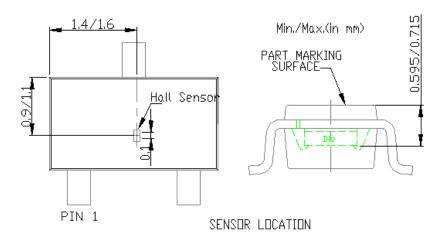
(1) Package Type: SC59 (Type A1)





	SC59 (Туре А	41)			
Dim	Min					
Α		1.45				
A1	0.00	0.15				
A2	0.90	1.30	1.15			
b	0.30	0.50				
С	0.08	0.22				
D		2.90 B	SC			
E		2.80 B	SC			
E1		1.60 B	SC			
е		0.95 B	SC			
e1		1.90 B	SC			
L	0.30	0.60	0.45			
L2	0.25 BSC					
θ1	5°	15°	10°			
All	Dimen	sions i	in mm			

AH32xxQ Hall sensor

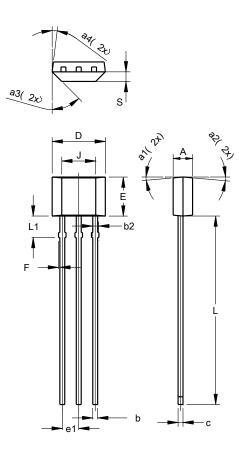




Package Outline Dimensions (continued) (All dimensions in mm.)

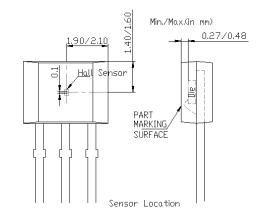
Please see http://www.diodes.com/package-outlines.html for the latest version.

(2) Package Type: SIP-3 (Bulk Pack)



S	IP-3 (Bu	Ik Pack	()
Dim	Min	Max	Тур
Α	1.40	1.60	1.50
b	0.33	0.43	0.38
b2	0.40	0.508	0.46
С	0.35	0.41	0.38
D	3.90	4.30	4.10
E	2.80	3.20	3.00
e1	1.24	1.30	1.27
F	0.00	0.20	
J	2	.62 REF	-
L	14.00	15.00	14.50
L1	1.55	1.75	1.65
S	0.63	0.84	0.74
a1		-	5°
a2			5°
a3	_	_	45°
a4	_	_	3°
All [Dimensi	ons in	mm

AH32xxQ SIP3 Hall sensor

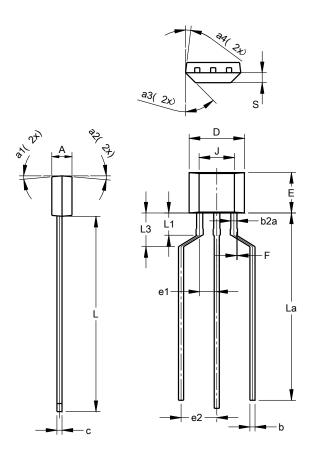




Package Outline Dimensions (continued) (All dimensions in mm.)

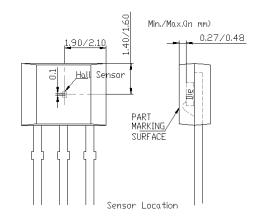
Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) Package Type: SIP-3 (Ammo Pack)



	SIF	0_3	
	(Ammo	-	
Dim	Min	Max	Тур
Α	1.40	1.60	1.50
b	0.33	0.43	0.38
b2a	0.40	0.52	0.46
c	0.35	0.41	0.38
D	3.90	4.30	4.10
E	2.80	3.20	3.00
e1	1.24	1.30	1.27
e2	2.40	2.90	2.65
F	0.00	0.20	—
J		.62 REF	
L	14.00	15.00	14.50
La	12.90	14.90	13.90
L1	1.55	1.75	1.65
L3	2.00	3.00	2.50
S	0.63	0.84	0.74
a1	—	_	5°
a2	_	_	5°
a3	_	_	45°
a4	_	_	3°
All [Dimensi	ons in	mm

AH32xxQ SIP3 Hall sensor

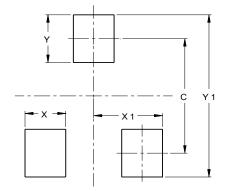




Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SC59 (Type A1)



Dimensions	Value (in mm)
С	2.40
Х	0.80
X1	1.35
Y	1.00
Y1	3.40



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